# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4702808

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
QINGKAI MEI	11/25/2017

## **RECEIVING PARTY DATA**

Name:	SHENZHEN MEIDONG ACOUSTICS CO., LTD.	
Street Address:	UNIT B 3TH FLOOR TOWER B, HONGZHUYONGQI TECHNOLOGY PARK, LEZHUJIAO, XIXIANG, BAOAN	
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State/Country:	CHINA	

## **PROPERTY NUMBERS Total: 5**

Property Type	Number
Application Number:	29619430
Application Number:	29619432
Application Number:	29619438
Application Number:	29619446
Application Number:	29621860

## **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:
QINGKAI MEI

SIGNATURE:
/Qingkai Mei/

DATE SIGNED:
11/25/2017
This document serves as an Oath/Declaration (37 CFR 1.63).

**Total Attachments: 1** 

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PATENT 504656086 REEL: 044219 FRAME: 0881

#### ASSIGNMENT OF PATENT APPLICATION

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Whereas I/we, Oingkai Mei have invented certain improvements in the:

U.S. Patent Application No. 29619430 Title of Invention: Headset Filing Date: 29 September 2017;

U.S. Patent Application No. 29619432 Title of Invention: Headset Filing Date: 29 September 2017;

U.S. Patent Application No. 29619438 Title of Invention: Headset Filing Date: 29 September 2017;

U.S. Patent Application No. 29619446 Title of Invention: Earphone Filing Date: 29 September 2017;

U.S. Patent Application No. 29621860 Title of Invention: Earphone Filing Date: 12 October 2017;

and whereas <u>Shenzhen MeiDong Acoustics Co., LTD.</u>, a corporation, having a place of business at <u>Unit B 3th Floor Tower B, Hongzhuyongqi Technology Park, Lezhujiao, Xixiang, Baoan, Shenzhen, Guangdong, China</u>, desires to acquire the entire right, title and interest in said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I the above named hereby sell, assign, and transfer to <a href="Shenzhen MeiDong Acoustics Co., LTD">Shenzhen MeiDong Acoustics Co., LTD</a>, its successors and assigns, the entire right, title and interest in said application and invention therein disclosed for the United States and foreign countries, and including, without limitation, any utility, continuation, divisional, and continuation-in-part applications, reissue, reexamination, extensions or foreign equivalents thereof, and all rights of priority and corresponding rights that are or may be secured under the laws of the United States and any foreign country, now or hereinafter in effect, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to <a href="Shenzhen MeiDong Acoustics Co., LTD">Shenzhen MeiDong Acoustics Co., LTD</a>, its successors and assigns; and I hereby agree that <a href="Shenzhen MeiDong Acoustics Co., LTD">Shenzhen MeiDong Acoustics Co., LTD</a>. may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by <a href="Shenzhen MeiDong Acoustics Co., LTD">Shenzhen MeiDong Acoustics Co., LTD</a>.

Signed

Inventor's signature: / Qingkai Mei / Date: 25 November, 2017

Name: Qingkai Mei

Residence: Unit B 3th Floor Tower B, Hongzhuyongqi Technology Park, Lezhujiao, Xixiang, Baoan,

Shenzhen, Guangdong, China

PATENT REEL: 044219 FRAME: 0882